



ITEM	Drawing	Description	QTY	Material
8	23-T0-16408	SOLDER	1	AgCu
7	23-T0-16407	SOLDER	1	AgCu
6	23-T0-16406	PIN	1	Kovar
5	23-T0-16405	PIN	1	Kovar
4	23-T0-16404	PIN	1	Kovar
3	23-T0-16403	CERAMIC	1	Al2O3 96%
2	23-T0-16402	STEM	1	OFHC
1	23-T0-16401	RING	1	SPCC

NOTES:

1. FINISH : Ni 2~6 μm MIN. + Au 1.3μm MIN.
2. ALLOW NON-PLATING BY RACKING AND PLATING WIRE
3. THE METALLIZATION POST PIN WIRE BOND AREA SHOULD BE WIREBONDABLE
4. THE PINS SHOULD BE SOLDERED STRONG ENOUGH TO MAINTAIN THEM NOT PULL OFF
5. UNNOTED TOLERANCE: ± 0.1

Date	Rev	Change	Sign	Date	Product Name:
					T088-3
Unit: mm		Scale: 5:1	Audit		Drawing No:
Total 1 Page		No. 1 Page	Approve		23-T0-164
					Rev:
					0